

20 V, 1 A low VF Schottky barrier rectifier

21 September 2023

**Product data sheet** 

### 1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 20 V
- Low forward voltage V<sub>F</sub> ≤ 415 mV
- Low reverse current
- Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package
- AEC-Q101 qualified

### 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- LED backlight for mobile application
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

### 4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
I <sub>F(AV)</sub>	average forward current	δ = 0.5; f = 20 kHz; square wave; T <sub>amb</sub> ≤ 110 °C	[1]	-	-	1	A
		δ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 135 °C		-	-	1	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	20	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; t <sub>p</sub> $\leq$ 300 µs; $\delta \leq$ 0.02; T <sub>j</sub> = 25 °C		-	370	415	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C		-	50	250	μA
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	4	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

# nexperia

### 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode[1]		
2	A	anode		К <del>Д</del> А <i>sym001</i>
			Transparent top view DFN1608D-2 (SOD1608)	

[1] The marking bar indicates the cathode.

### 6. Ordering information

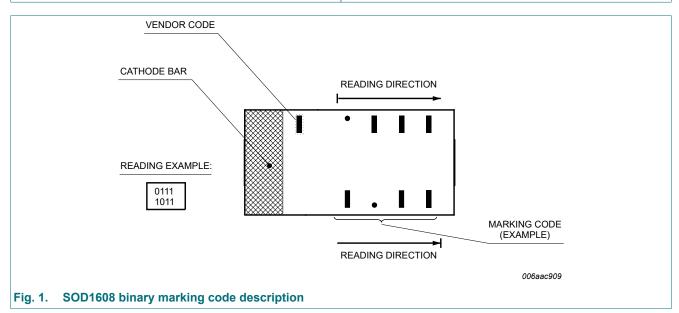
Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PMEG2010EPK		plastic, leadless ultra small plastic package with side- wettable flanks (SWF); 2 terminals; 0.94 mm pitch; 1.6 mm x 0.8 mm x 0.37 mm body	<u>SOD1608</u>		

# 7. Marking

### Table 4. Marking codes

Type number	Marking code
PMEG2010EPK	0100
	0000



### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	20	V
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 130 °C		-	1.4	A
I <sub>F(AV)</sub>	average forward current	δ = 0.5; f = 20 kHz; square wave; T <sub>amb</sub> ≤ 110 °C	[1]	-	1	A
		δ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 135 °C		-	1	A
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25$		-	3	A
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 8 ms; square wave; T <sub>j(init)</sub> = 25 °C		-	5	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	410	mW
			[3]	-	860	mW
			[1]	-	1565	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 9. Thermal characteristics

Table 6	. Thermal	characteristics
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	305	K/W
	junction to ambient		[1] [3]	-	-	145	K/W
		[1]	[1] [4]	-	-	80	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	20	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.

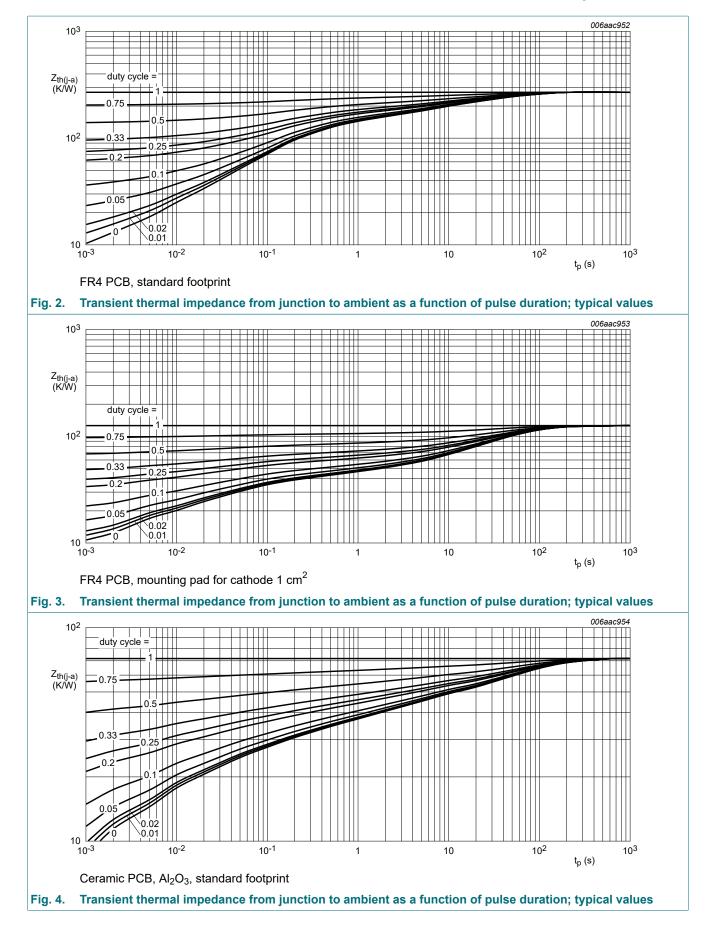
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

[4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

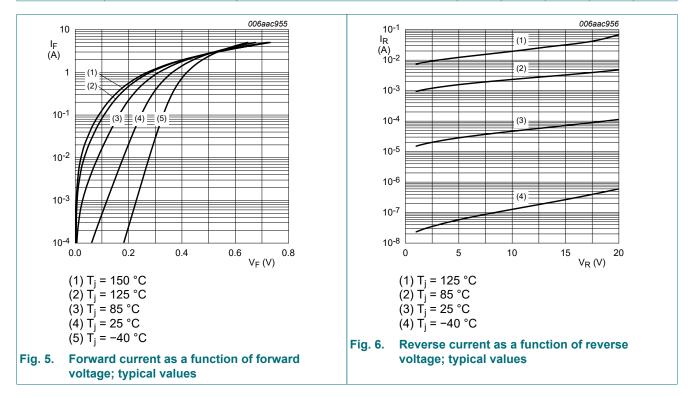
[5] Soldering point of cathode tab.

#### 20 V, 1 A low VF Schottky barrier rectifier

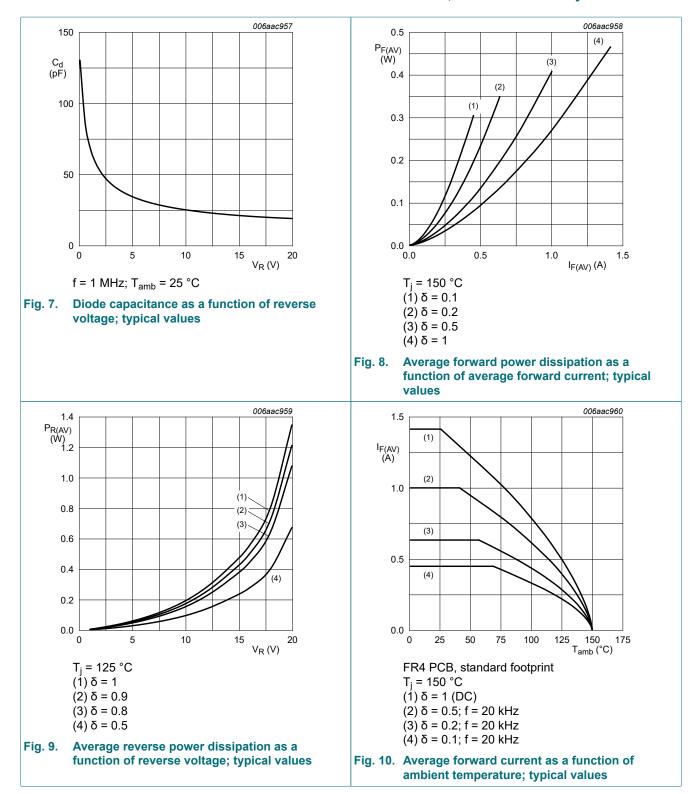


## **10. Characteristics**

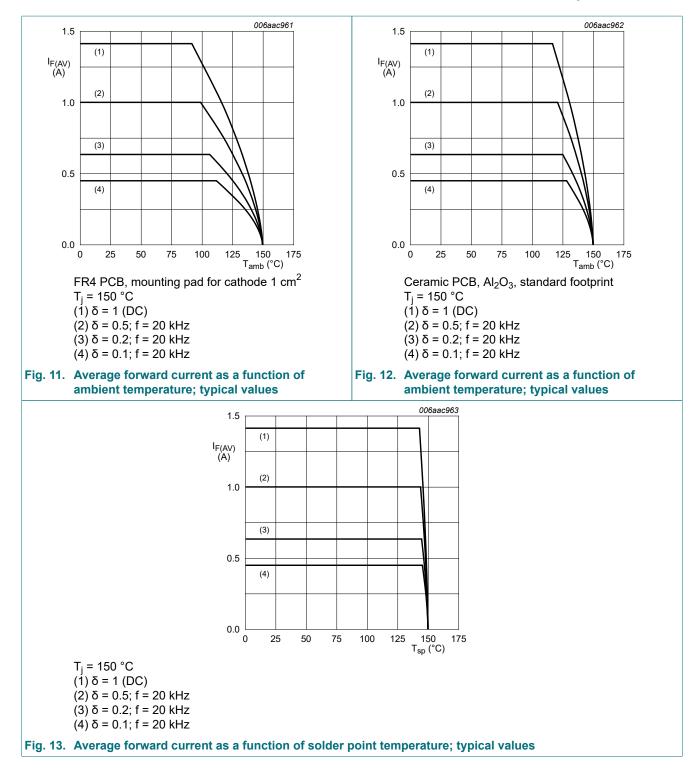
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VF	forward voltage	I <sub>F</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; $\delta \le$ 0.02; T <sub>j</sub> = 25 °C	-	240	280	mV
		$I_F$ = 500 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	310	350	mV
		$I_F$ = 700 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	330	390	mV
		$\begin{array}{l} I_F = 1 \text{ A; pulsed; } t_p \leq \ 300 \ \mu\text{s; } \delta \leq \ 0.02; \\ T_j = 25 \ ^\circ\text{C} \end{array}$	-	370	415	mV
I <sub>R</sub> reverse currer	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	50	250	μA
		V <sub>R</sub> = 20 V; T <sub>j</sub> = 25 °C	-	150	600	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	65	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	25	-	pF
t <sub>rr</sub>	reverse recovery time	$    I_{F} = 0.5 \text{ A}; \ I_{R} = 0.5 \text{ A}; \ I_{R(meas)} = 0.1 \text{ A}; \\ T_{j} = 25 \ ^{\circ}\text{C} $	-	4	-	ns
V <sub>FRM</sub>	peak forward recovery voltage	I <sub>F</sub> = 0.5 A; dI <sub>F</sub> /dt = 20 A/μs; T <sub>j</sub> = 25 °C	-	335	-	mV



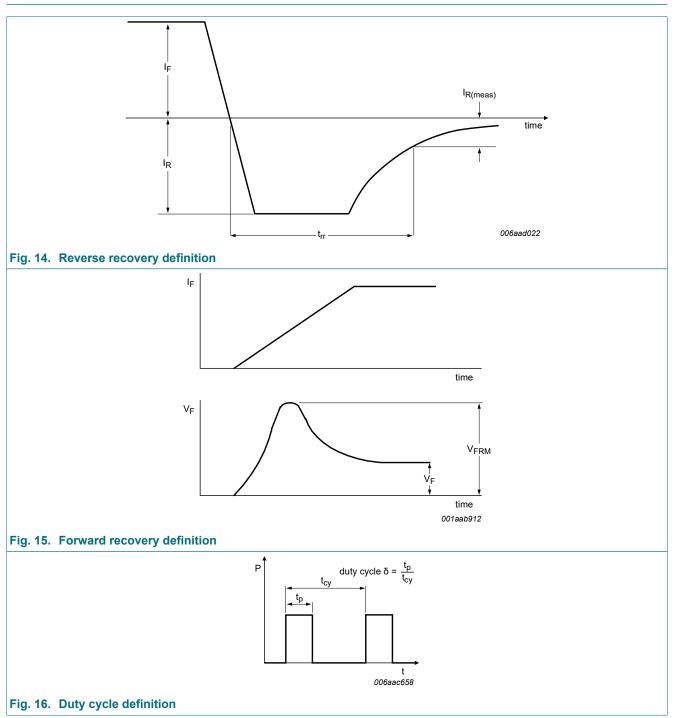
#### 20 V, 1 A low VF Schottky barrier rectifier



#### 20 V, 1 A low VF Schottky barrier rectifier



# **11. Test information**



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,

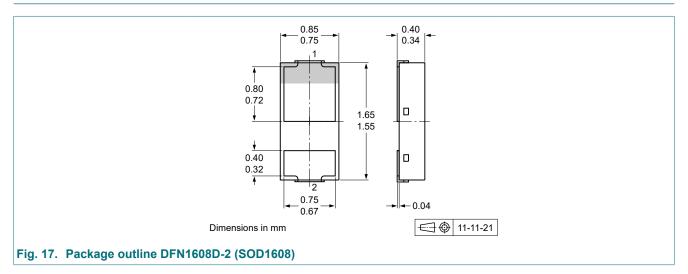
 $I_{RMS} = I_{F(AV)}$  at DC,

 $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

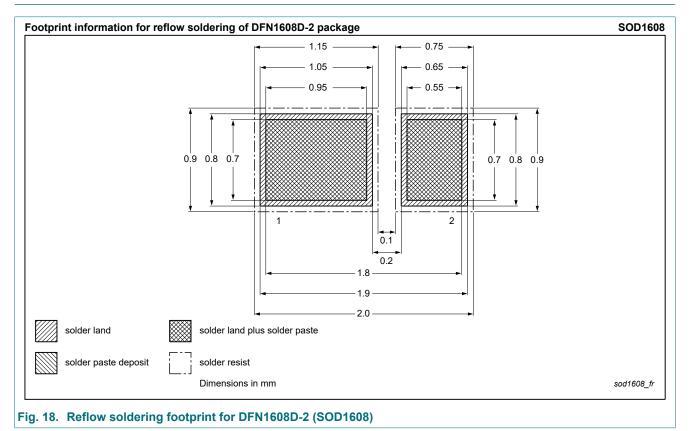
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

### 12. Package outline



### 13. Soldering



# 14. Revision history

ry					
Release date	Data sheet status	Change notice	Supersedes		
20230921	Product data sheet	-	PMEG2010EPK v.2		
<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
20120314	Product data sheet	-	PMEG2010EPK v.1		
20120120	Product data sheet	-	-		
	Release date         20230921         • The format of this da Nexperia.         • Legal texts have bee         20120314	Release date     Data sheet status       20230921     Product data sheet       • The format of this data sheet has been redesined by Nexperia.     Nexperia.       • Legal texts have been adapted to the new control 20120314     Product data sheet	Release date       Data sheet status       Change notice         20230921       Product data sheet       -         * The format of this data sheet has been redesigned to comply with the i Nexperia.       -         * Legal texts have been adapted to the new company name where approx         20120314       Product data sheet		

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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# Contents

1.	General description	.1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	.1
5.	Pinning information	.2
6.	Ordering information	.2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	3
10.	Characteristics	5
11.	Test information	. 8
12.	Package outline	9
13.	Soldering	9
14.	Revision history1	0
	Legal information1	

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